

FEATURES

Broadband RF, IF, and LO ports
Conversion loss: 6 dB
Noise figure: 6 dB
High input IP₃: 26 dBm
High input P_{1dB}: 17 dBm
Low LO drive level
Single-ended design: no need for baluns
Single-supply operation: 3 V @ 10 mA
Miniature 8-lead 3 mm x 2 mm LFCSP package
RoHS compliant

APPLICATIONS

Cellular base station
Point-to-point radio links
RF instrumentation

GENERAL DESCRIPTION

The ADL5350 is a high linearity, up-and-down converting mixer capable of operating over a broad input frequency range. It is well suited for demanding cellular base-station mixer designs that require high sensitivity and efficient blocker immunity. Based on a GaAs pHEMT single-ended mixer architecture, the ADL5350 provides excellent input linearity and low noise figure without the need for a high power level, local oscillator (LO) drive.

In 850 MHz/900 MHz receive applications, the ADL5350 provides a typical conversion loss of only 6 dB. The integrated LO amplifier allows a low LO drive level, typically only 4 dBm for most applications. The input IP₃ is typically greater than 25 dBm, with an input compression point of 17 dBm. The high input linearity of the ADL5350 makes the device an excellent mixer for communications systems that require high blocker immunity, such as GSM 850/900 and 800 MHz CDMA2000. At 2 GHz, a slightly greater supply current is required to obtain similar performance.

FUNCTIONAL BLOCK DIAGRAM

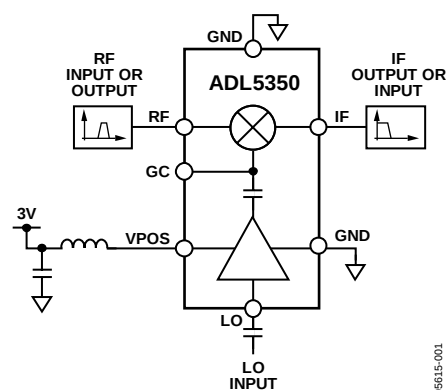


Figure 1.

For low frequency applications, the ADL5350 provides access to the gate contact of the output-mixing device. This allows an external LO coupling capacitor to be applied between the VPOS pin and GC pin, helping to improve the LO drive to the switching device. Using a single 100 pF capacitor allows high performance at the lower LO frequencies.

The single-ended broadband RF/IF port allows the device to be customized for a desired band of operation using simple external filter networks. The LO to RF isolation is based on the LO rejection of the RF port filter network. Greater isolation may be achieved using higher order filter networks as described in the Applications section of this data sheet.

The ADL5350 is fabricated on a GaAs pHEMT high performance IC process. The ADL5350 is available in a 3 mm × 2 mm 8-lead LFCSP package. It operates over a -40°C to +85°C temperature range. An evaluation board is also available.

Rev. PrC

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SPECIFICATIONS

820 MHz RECEIVE PERFORMANCE

$V_S = 3\text{ V}$, $T_A = 25^\circ\text{C}$, LO power = 4 dBm, re: 50 Ω , unless otherwise noted.

Table 1.

Parameter	Min	Typ	Max	Unit	Conditions
RF Frequency Range	750	850	975	MHz	Low Side LO
LO Frequency Range	500	780	945	MHz	
IF Frequency Range	30	70	250	MHz	
Conversion Loss		6.3		dB	$f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$, $f_{IF} = 70\text{ MHz}$
SSB Noise Figure		5.6		dB	$f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$, $f_{IF} = 70\text{ MHz}$
Input Third-Order Intercept		27.6		dBm	$f_{RF1} = 819\text{ MHz}$, $f_{RF2} = 821\text{ MHz}$, $f_{LO} = 750\text{ MHz}$ $f_{IF} = 70\text{ MHz}$, each RF tone 0 dBm
Input 1 dB Compression Point		17.8		dBm	$f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$, $f_{IF} = 70\text{ MHz}$
LO to IF Leakage		-28		dBc	LO Power = 4 dBm, $f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$
LO to RF Leakage		-16		dBc	LO Power = 4 dBm, $f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$
RF to IF Leakage		-17		dBc	RF Power = 0 dBm, $f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$
IF/2 Spurious		-50		dBc	RF Power = 0 dBm, $f_{RF} = 820\text{ MHz}$, $f_{LO} = 750\text{ MHz}$
Supply Voltage	2.7	3	5.5	V	
Supply Current		10		mA	LO Power = 4 dBm

1950 MHz RECEIVE PERFORMANCE

$V_S = 3\text{ V}$, $T_A = 25^\circ\text{C}$, LO power = 6 dBm, re: 50 Ω , unless otherwise noted.

Table 2.

Parameter	Min	Typ	Max	Unit	Conditions
RF Frequency Range	1800	1950	2050	MHz	Low Side LO
LO Frequency Range	1420	1760	2000	MHz	
IF Frequency Range	50	190	380	MHz	
Conversion Loss		7.2		dB	$f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$, $f_{IF} = 190\text{ MHz}$
SSB Noise Figure		6.8		dB	$f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$, $f_{IF} = 190\text{ MHz}$
Input Third-Order Intercept		26.6		dBm	$f_{RF1} = 1949\text{ MHz}$, $f_{RF2} = 1951\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$ $f_{IF} = 190\text{ MHz}$, each RF tone 0 dBm
Input 1 dB Compression Point		16		dBm	$f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$, $f_{IF} = 190\text{ MHz}$
LO to IF Leakage		-12.5		dBc	LO Power = 6 dBm, $f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$
LO to RF Leakage		-10.5		dBc	LO Power = 6 dBm, $f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$
RF to IF Leakage		-10		dBc	RF Power = 0 dBm, $f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$
IF/2 Spurious		-54		dBc	RF Power = 0 dBm, $f_{RF} = 1950\text{ MHz}$, $f_{LO} = 1760\text{ MHz}$
Supply Voltage	2.7	3	5.5	V	
Supply Current		24		mA	LO Power = 6 dBm

SPUR TABLES

All spur tables are $N \times f_{RF} - M \times f_{LO}$ -mixer spurious products for 0 dBm input power, unless otherwise noted.

450 MHz SPUR TABLE

Table 3.

		M															
		0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
N	0	-5.7	-16.2	-25.5	-16.2	-23.9	-22.3	-27.1	-24.7	-27.1	-26.8	-38.6	-30.2	-29.9	-27.2	-29.2	-34.8
	1	-24.9	-5.7	-30.1	-18.8	-25.2	-24.0	-24.3	-37.1	-26.5	-53.1	-32.0	-44.0	-59.3	-46.0	-52.3	-43.3
	2	-47.4	-57.5	-51.1	-60.2	-53.8	-55.2	-52.5	-50.8	-57.7	-51.4	-65.0	-53.1	-63.9	-77.5	-68.7	-75.5
	3	-70.5	-75.3	-70.2	-79.7	-69.5	-76.6	-66.9	-74.5	-73.0	-74.7	-75.5	-71.4	-74.6	-75.3	-75.6	-76.1
	4	-78.4	-73.1	-82.4	-79.3	-79.5	-77.5	-84.5	-77.8	-82.2	-77.6	-88.4	-82.7	-77.9	-72.8	-77.1	-83.6
	5	-82.7	-76.6	-77.1	-89.8	-77.6	-76.1	-79.3	-79.3	-83.1	-81.1	-78.4	-79.6	-80.2	-77.9	-85.6	-79.1
	6	-90.6	-79.2	-82.2	-84.3	-81.2	-96.3	-75.8	-80.1	-80.7	-76.9	-82.5	-74.4	-84.0	-88.9	-89.6	-77.9
	7	-78.9	-74.4	-77.0	-83.2	-80.1	-86.3	-78.9	-87.2	-76.5	-81.5	-82.8	-83.6	-88.7	-73.5	-78.3	-78.4
	8	-77.3	-73.6	-79.0	-80.4	-78.6	-79.6	-83.3	-81.0	-77.4	-70.4	-77.0	-79.7	-90.7	-78.0	-76.2	-77.0
	9	-80.8	-78.5	-76.7	-78.7	-84.8	-80.4	-81.1	-76.9	-80.7	-79.6	-76.0	-91.3	-90.5	-91.4	-96.8	-75.7
	10	-78.9	-77.1	-77.0	-84.0	-87.0	-81.2	-84.4	-90.2	-75.8	-77.5	-90.4	-82.8	-83.0	-87.9	-81.9	-83.1
	11	-77.5	-80.4	-78.7	-86.7	-79.1	-76.4	-85.9	-78.7	-83.4	-85.2	-78.6	-92.3	-80.3	-75.7	-78.3	-75.4
	12	-81.3	-81.6	-81.3	-76.8	-81.5	-78.5	-78.5	-89.7	-74.4	-73.3	-77.0	-78.5	-75.2	-75.4	-91.3	-90.7
	13	-79.9	-81.3	-77.4	-78.7	-79.7	-76.7	-77.7	-85.8	-77.0	-78.9	-84.5	-75.0	-81.0	-78.6	-75.8	-82.0
	14	-82.7	-77.6	-79.6	-76.3	-82.3	-79.8	-79.2	-83.5	-83.5	-91.4	-78.9	-102.8	-75.6	-80.2	-79.5	-87.4
15	-79.7	-82.9	-79.6	-75.7	-78.8	-78.6	-78.7	-79.8	-77.7	-78.4	-78.7	-80.6	-79.0	-80.4	-87.0	-80.3	

820 MHz SPUR TABLE

Table 4.

	M															
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
N	0	-6.22	-14.7	-12.8	-13.3	-14.2	-30.1	-27.1	-20.4	-20.2	-22.1	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
	1	-18.8	-6.22	-33	-20.3	-21.4	-44.5	-38.5	-43.1	-39	-31.3	-33.1	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
	2	-44.6	-71.6	-50	-64.8	-51.7	-53.7	-60.1	-64.3	-74.8	-61.5	-56.8	-55.1	N.M. ¹	N.M. ¹	N.M. ¹
	3	-73.4	-76.8	-69.8	-72.8	-75.5	-79.6	-97.5	-72.3	-79.5	-84.4	-77.8	-74.9	-74.5	N.M. ¹	N.M. ¹
	4	-78.2	-77.8	-85.8	-91.3	-80.8	-78.2	-80.9	-76.1	-80.3	-79.4	-81.1	-79.3	-78.1	-77.6	N.M. ¹
	5	-82.1	-80.8	-85.2	-81.4	-87.1	-79.5	-84.7	-108	-90.2	-84.5	-76.4	-75.1	-80.9	-78.8	-83.3
	6	-77.6	-78.6	-80.6	-78.3	-83.2	-70.8	-77.5	-86.8	-84.9	-81.7	-76.7	-81	-79.4	-78.6	-77.1
	7	-80.2	-76.6	-83.1	-75.8	-82.4	-78.2	-78.7	-80.7	-83	-76.5	-88.9	-77.7	-77.3	-80.2	-78.9
	8	-83.5	-80.6	-81.7	-79	-84.1	-78.4	-79.5	-86.3	-79	-76.1	-86.7	-79.5	-88.8	-73.9	-79.7
	9	N.M. ¹	-78.7	-76.3	-78.1	-82.6	-78.2	-78.5	-87.7	-82.1	-76.7	-94.1	-81.2	-87.5	-80.3	-81.9
	10	N.M. ¹	N.M. ¹	-78.7	-78.4	-80.8	-75.4	-76.6	-86	-84	-81.2	-75.5	-72.5	-78.1	-77.1	-81.8
	11	N.M. ¹	N.M. ¹	N.M. ¹	-79	-76.7	-81.5	-79.1	-78.2	-76.1	-83	-75	-77.8	-84.1	-79.1	-79.1
	12	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-76.4	-78.8	-77	-79.4	-81.8	-78.6	-82.8	-79.3	-76.8	-75.8	-82.2
	13	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-82	-77.7	-80.8	-79.8	-76.6	-79.3	-82.1	-94.9	-74.6	-83.3
	14	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-84.2	-78	-81.7	-80.3	-79.3	-77.7	-75.8	-86.9	-77.3	-77
	15	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-77	-79.5	-82.2	-80.7	-75.3	-76.1	-79.7	-78.6

¹ N.M. indicates that a frequency was not measured. N.M. spurs are either less than -100 dBm or correspond to a frequency greater than 5995 MHz.

1950 MHz SPUR TABLE

Table 5.

	M															
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	-7.8	-2.08	-16.6	-31.7	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
1	-9.6	-7.81	-36.2	-27.2	-41.1	-28	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
2	-54.7	-74.9	-54	-62	-58.5	-78.6	-57.2	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
3	-81.1	-78.6	-78.7	-85.4	-82.1	-75.6	-79.6	-79.4	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
4	N.M. ¹	-78	-83.8	-86.4	-84.1	-79.2	-77.5	-77.2	-81.9	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
5	N.M. ¹	N.M. ¹	-73.9	-82.8	-82.3	-87.8	-80.1	-74.7	-79.3	-82.1	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
6	N.M. ¹	N.M. ¹	N.M. ¹	-80.1	-82.1	-86.7	-83.4	-80.7	-88.2	-79.5	-86.3	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
7	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-79	-80.6	-80	-76.5	-81.4	-81.8	-75.2	-77.4	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹
8	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-79.6	-83.2	-81.5	-81.5	-85.5	-80.9	-79.3	-79.5	N.M. ¹	N.M. ¹	N.M. ¹
9	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-83.7	-89	-83.1	-79.7	-80.6	-81	-82.9	-78.7	N.M. ¹	N.M. ¹
10	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-80.9	-76.4	-82.7	-79.2	-78.8	-77.9	-80.7	-79.6
11	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-77.8	-81.8	-79.7	-88.3	-73.9	-80.9	-79.5
12	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-79.6	-78.7	-77.6	-87.1	-86.6	-76.7
13	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-74.4	-81.6	-83	-82.9	-80.7
14	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-78.9	-82	-74.6	-80.4
15	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	N.M. ¹	-78.7	-73.1	-78.1

¹ N.M. indicates that a frequency was not measured. N.M. spurs are either less than -100 dBm or correspond to a frequency greater than 5995 MHz.

ABSOLUTE MAXIMUM RATINGS

Table 6.

Parameter	Rating
Supply Voltage, V_S	6.0 V
RF Input Level	20 dBm
LO Input Level	20 dBm
Internal Power Dissipation	324 mW
θ_{JA}	154.3 °C/W
Maximum Junction Temperature	135°C
Operating Temperature Range	–40°C to +85°C
Storage Temperature Range	–65°C to +150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

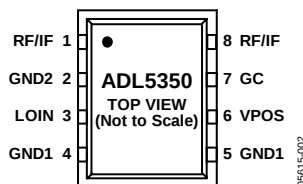


Figure 2. Pin Configuration

Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Function
1, 8	RF/IF	RF and IF Input/Output Ports. These nodes are internally tied together. RF and IF port separation is achieved using external tuning networks.
2	GND2	Device Common (DC Ground) for RFIF Switching Circuitry.
3	LOIN	LO Input, AC-Coupled.
4, 5	GND1	Device Common (DC Ground) for LO Buffer Circuitry.
6	VPOS	Positive Supply Voltage for the Drain of the LO Buffer. A series RF choke is needed on the supply line to provide proper ac-loading of the LO buffer amplifier.
7	GC	Gate Contact of Mixing Device. Typically not connected for high frequency mixing. Connecting capacitor between GC and VPOS permits low frequency applications.

TYPICAL PERFORMANCE CHARACTERISTICS

820 MHz CHARACTERISTICS

$V_{POS} = 3\text{ V}$, RF Frequency = 820 MHz, IF Frequency = 70 MHz, RF Level = -10 dBm, LO Level = 4 dBm, Temperature = 25°C, unless otherwise noted.

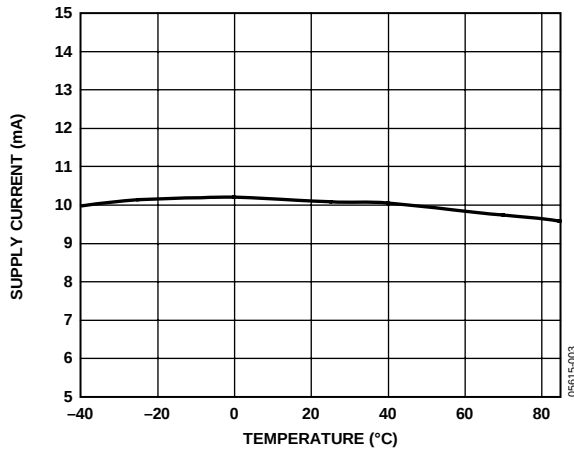


Figure 3. Current vs. Temperature

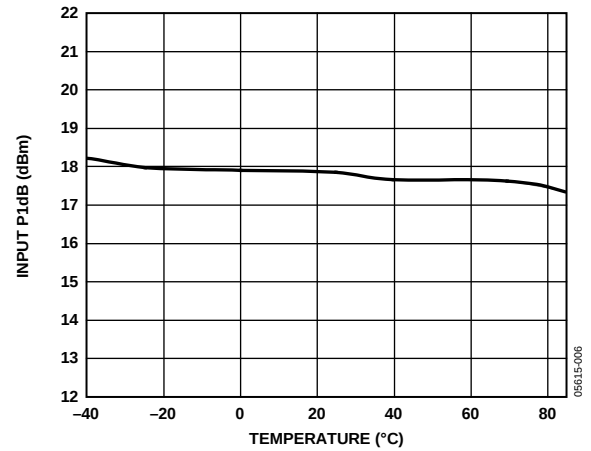


Figure 6. Input Compression vs. Temperature

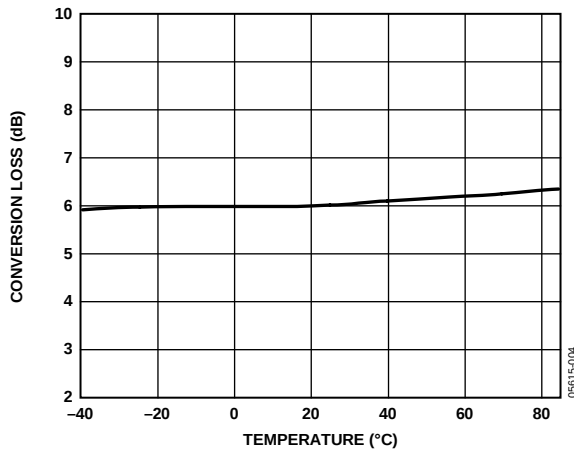


Figure 4. Conversion Loss vs. Temperature

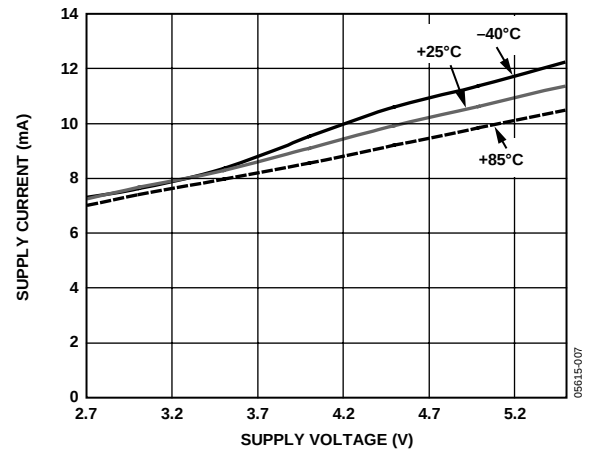


Figure 7. Current vs. V_{POS}

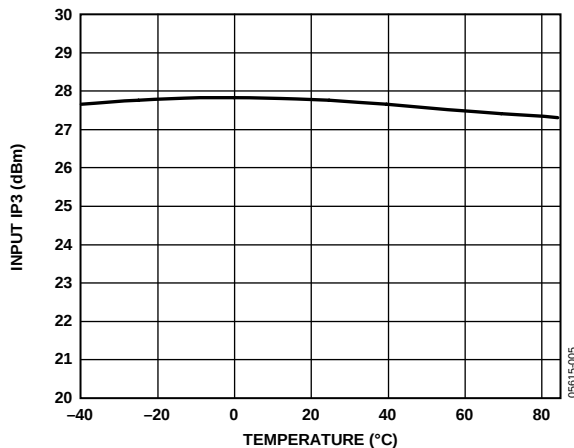


Figure 5. IIP3 vs. Temperature

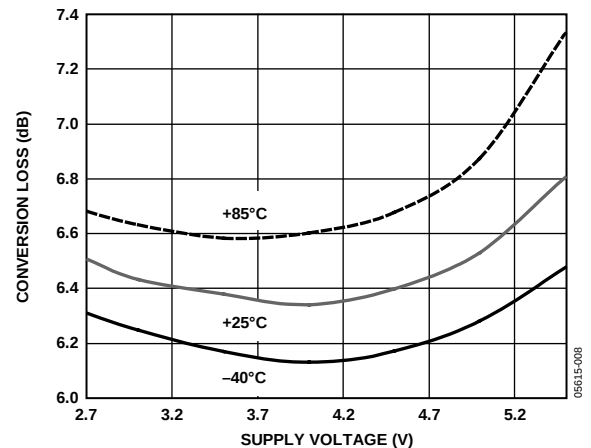


Figure 8. Conversion Loss vs. V_{POS}

820 MHz CHARACTERISTICS

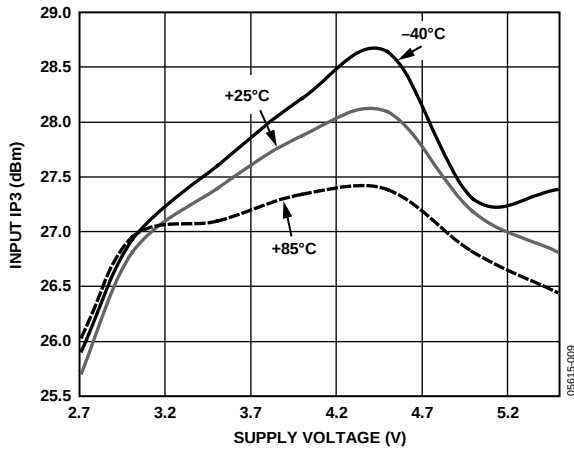


Figure 9. IIP3 vs. VPOS

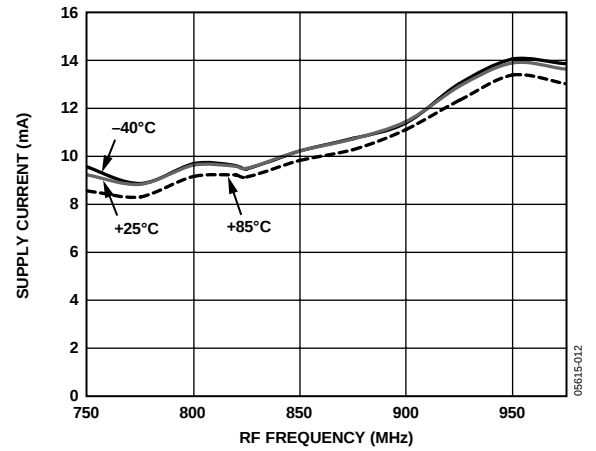


Figure 12. Current vs. RF Frequency

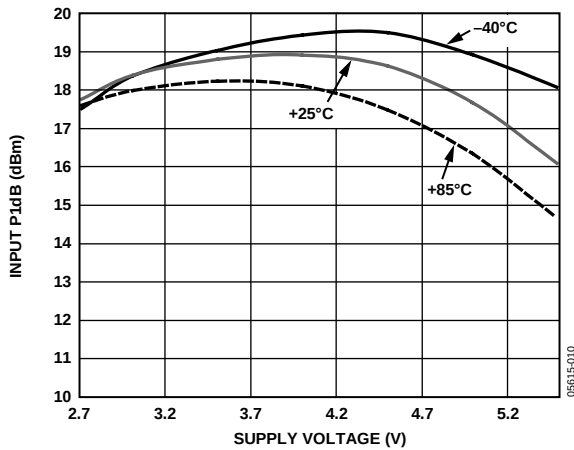


Figure 10. Input Compression vs. VPOS

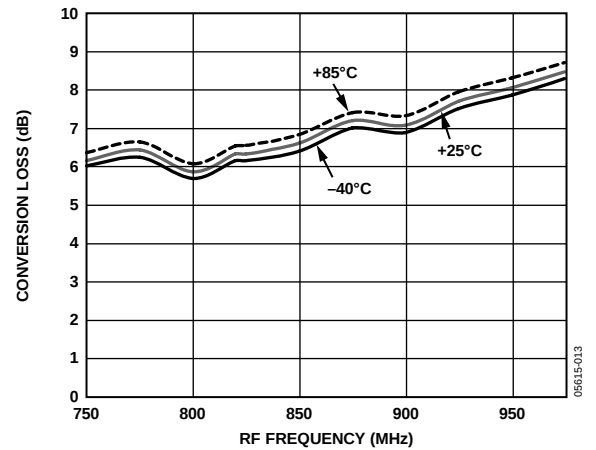


Figure 13. Conversion Loss vs. RF Frequency

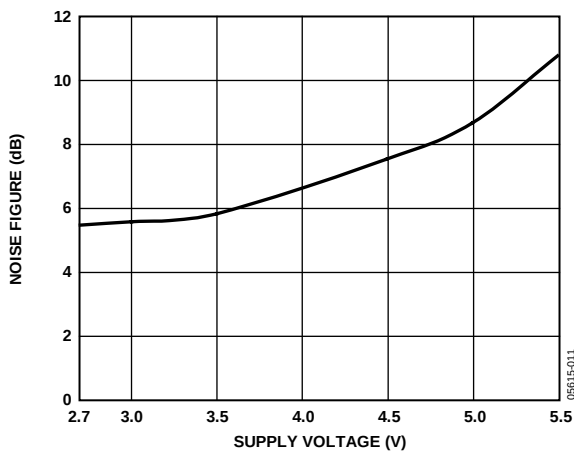


Figure 11. Noise Figure vs. VPOS

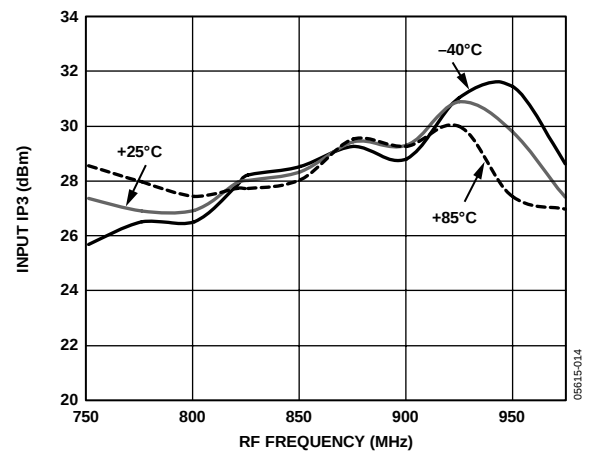


Figure 14. IIP3 vs. RF Frequency

820 MHz CHARACTERISTICS

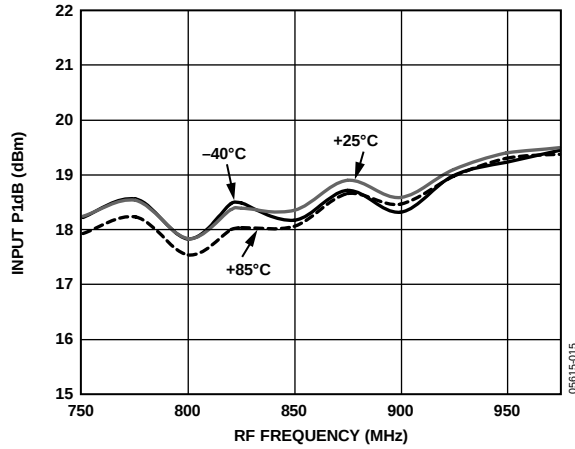


Figure 15. Input Compression vs. RF Frequency

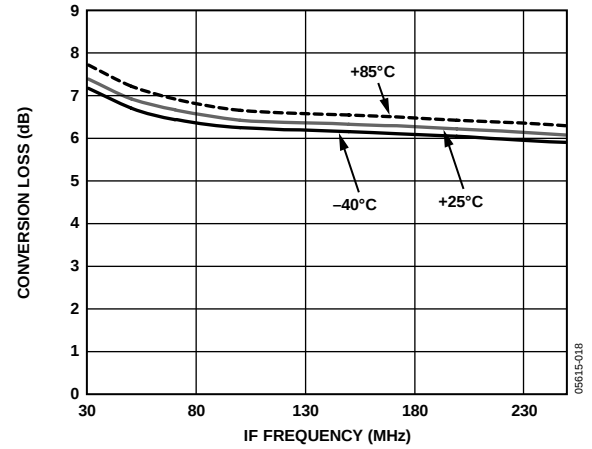


Figure 18. Conversion Loss vs. IF Frequency

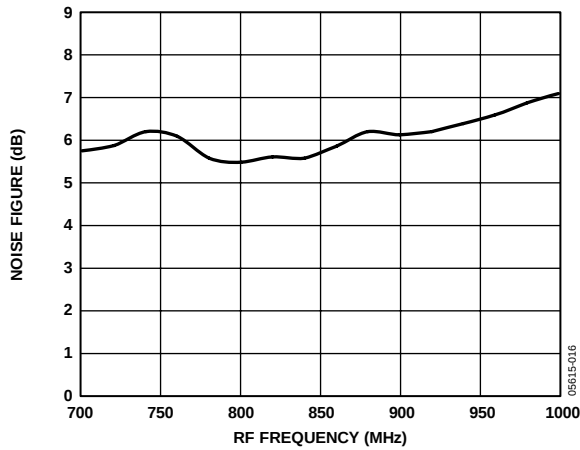


Figure 16. Noise Figure vs. RF Frequency

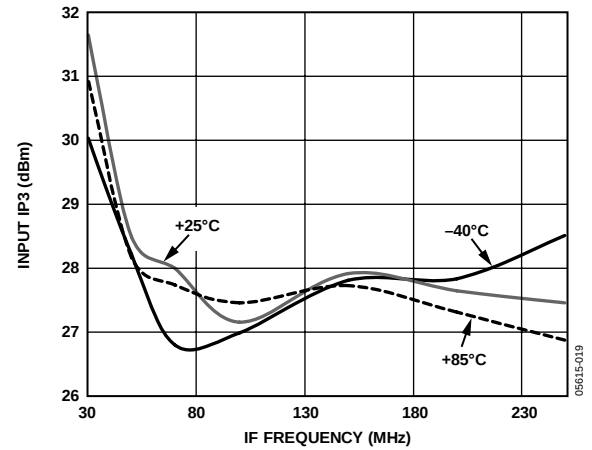


Figure 19. IIP3 vs. IF Frequency

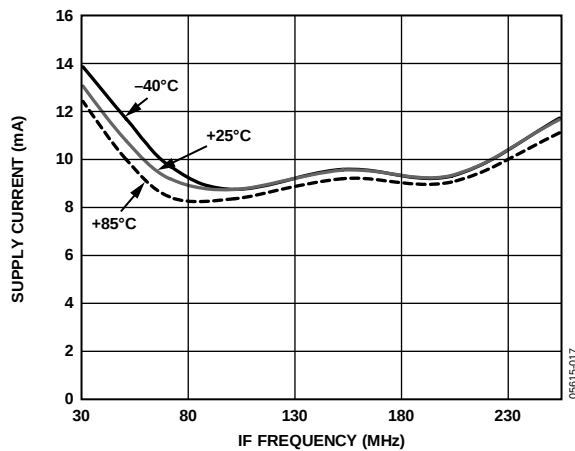


Figure 17. Current vs. IF Frequency

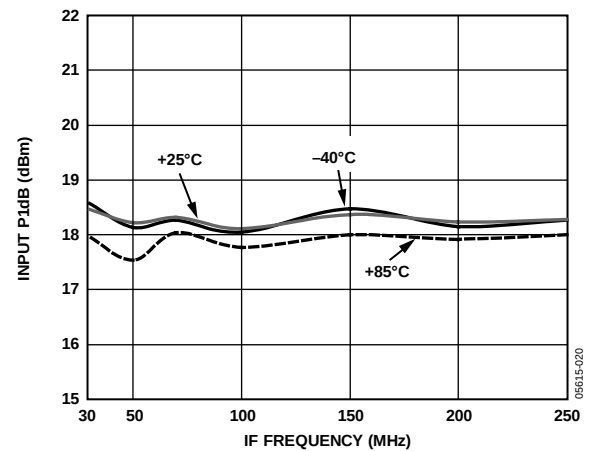


Figure 20. Input Compression vs. IF Frequency

820 MHz CHARACTERISTICS

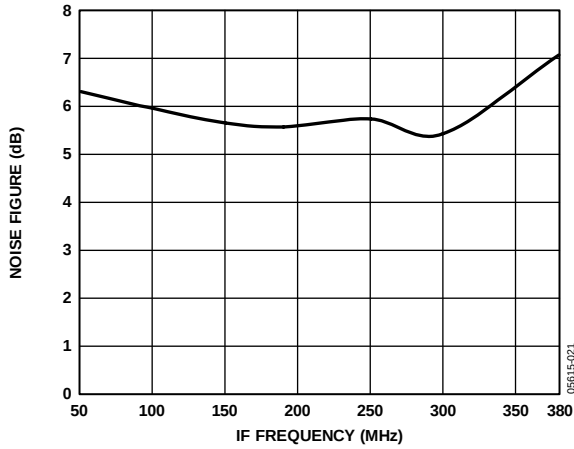


Figure 21. Noise Figure vs. IF Frequency

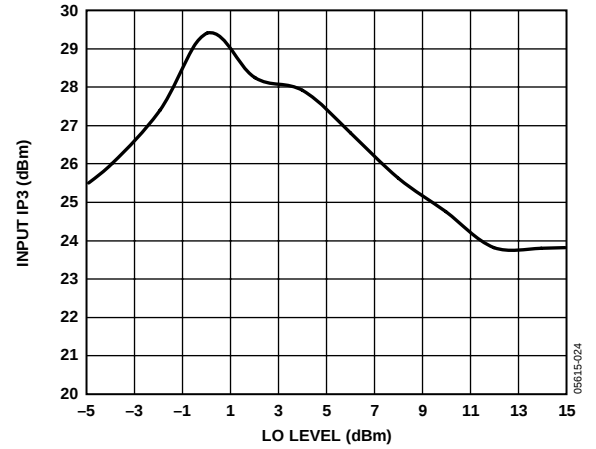


Figure 24. IIP3 vs. LO Level

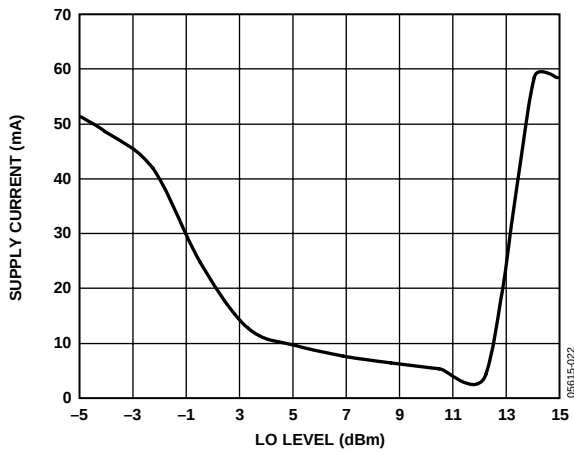


Figure 22. Current vs. LO Level

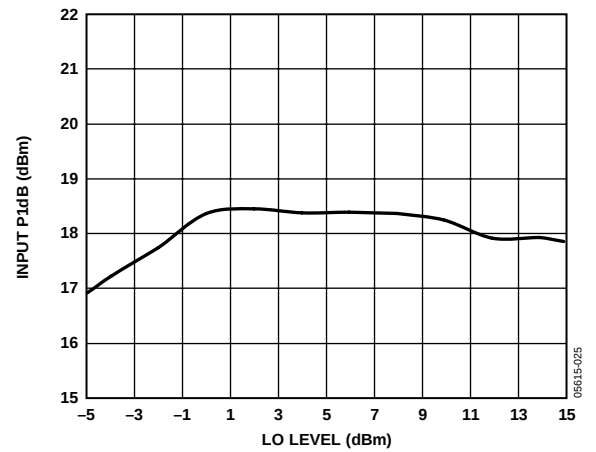


Figure 25. Input Compression vs. LO Level

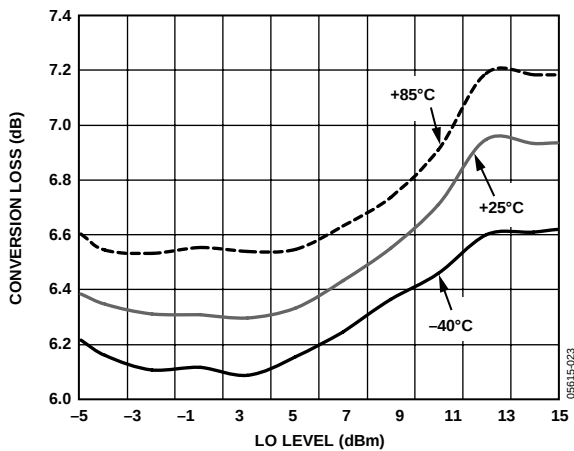


Figure 23. Conversion Loss vs. LO Level

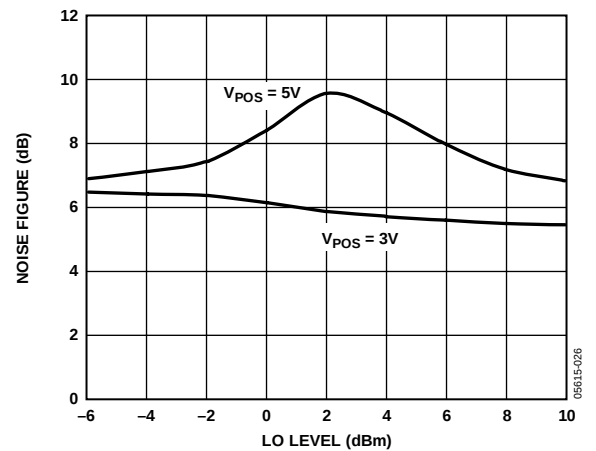


Figure 26. Noise Figure vs. LO Level

820 MHz CHARACTERISTICS

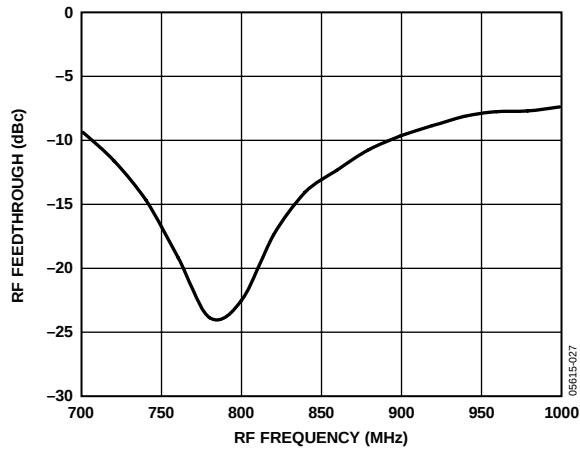


Figure 27. RF to IF Feedthrough vs. RF Frequency

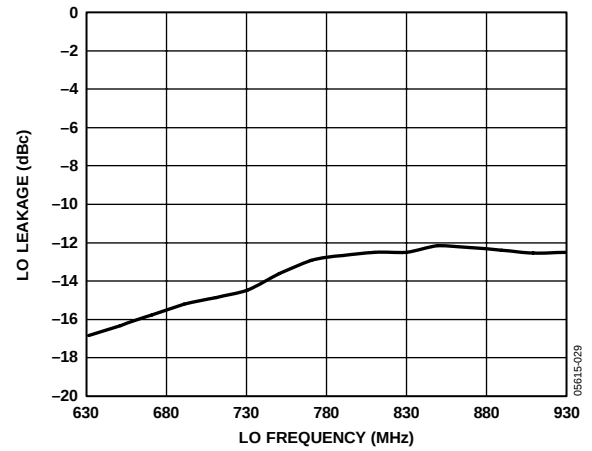


Figure 29. LO to RF Leakage vs. LO Frequency

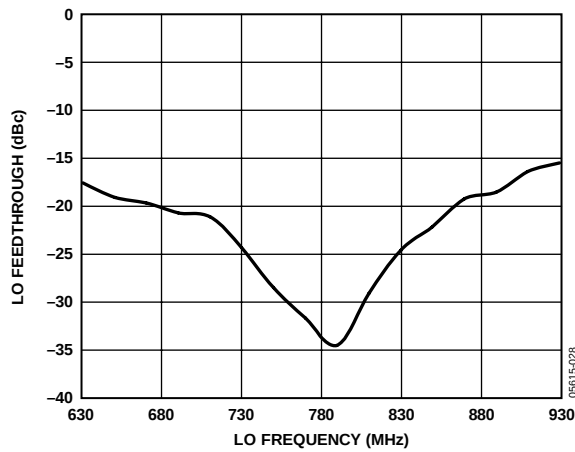


Figure 28. LO to IF Feedthrough vs. LO Frequency

1950 MHz CHARACTERISTICS

$V_{POS} = 3\text{ V}$, RF Frequency = 1950 MHz, IF Frequency = 190 MHz, RF Level = -10 dBm, LO Level = 6 dBm, Temperature = 25°C, unless otherwise noted.

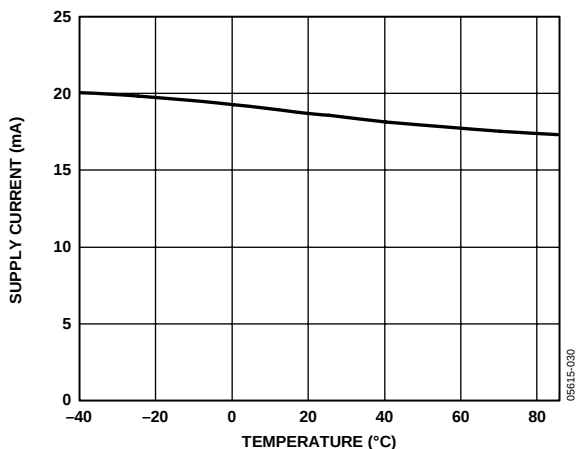


Figure 30. Current vs. Temperature

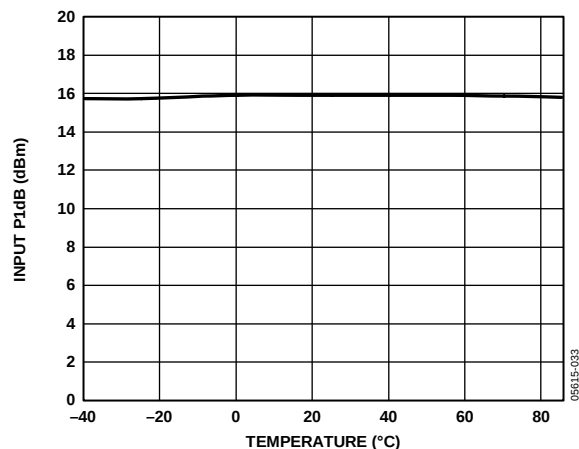


Figure 33. Input Compression vs. Temperature

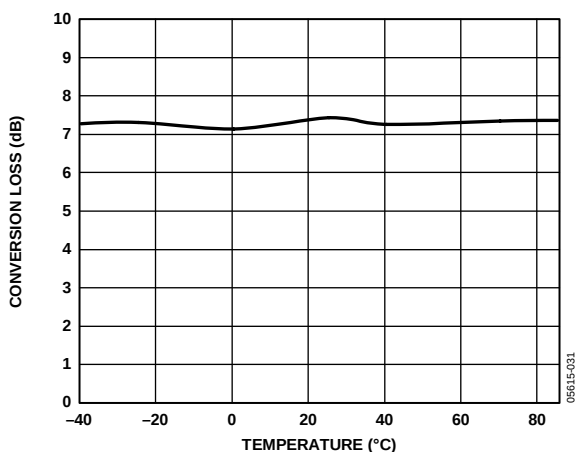


Figure 31. Conversion Loss vs. Temperature

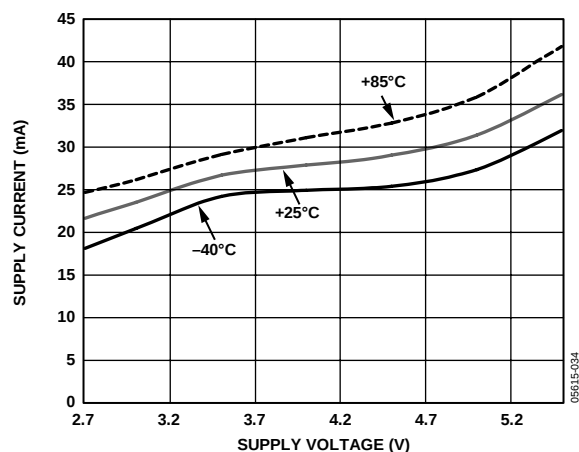


Figure 34. Current vs. VPOS

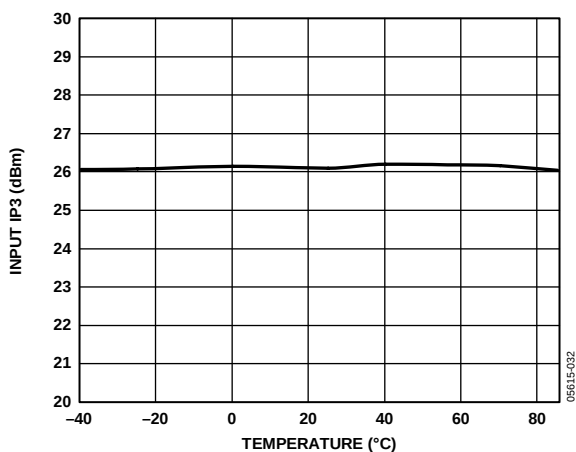


Figure 32. IIP3 vs. Temperature

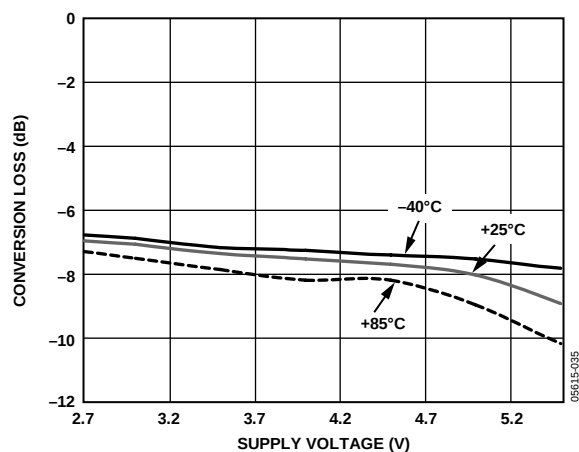


Figure 35. Conversion Loss vs. VPOS

1950 MHz CHARACTERISTICS

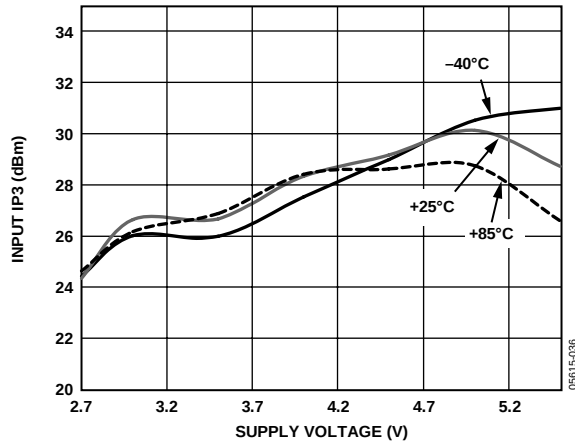


Figure 36. IIP3 vs. VPOS

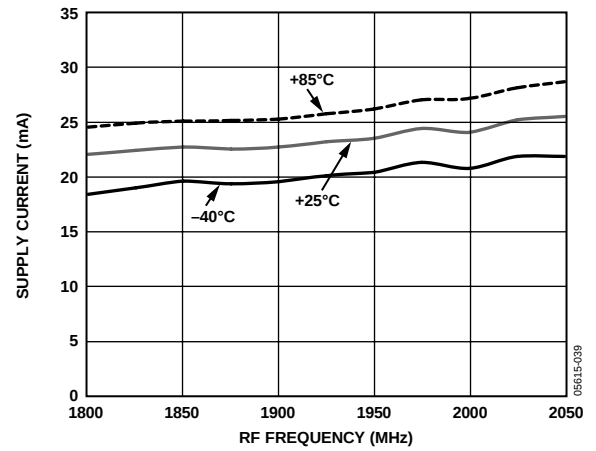


Figure 39. Current vs. RF Frequency

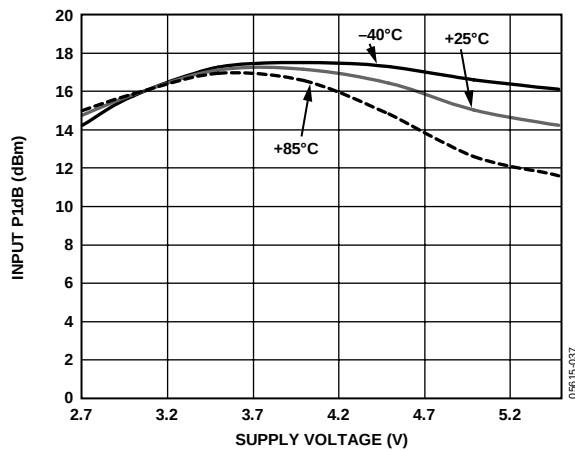


Figure 37. Input Compression vs. VPOS

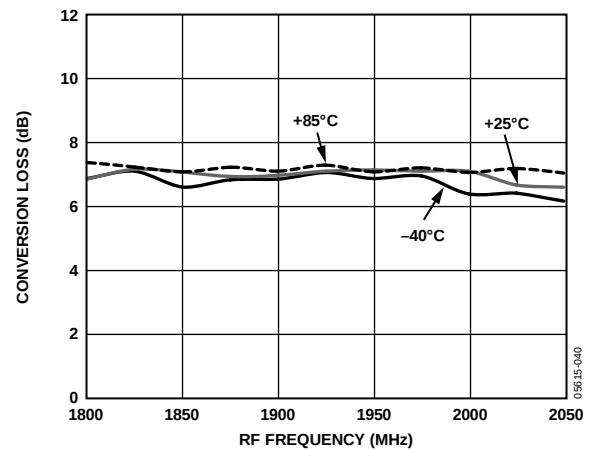


Figure 40. Conversion Loss vs. RF Frequency

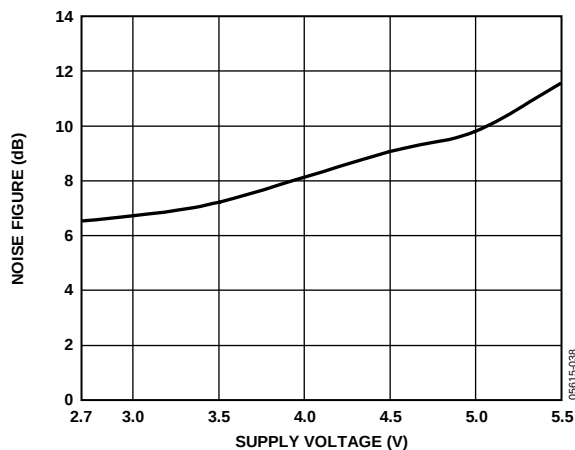


Figure 38. Noise Figure vs. VPOS

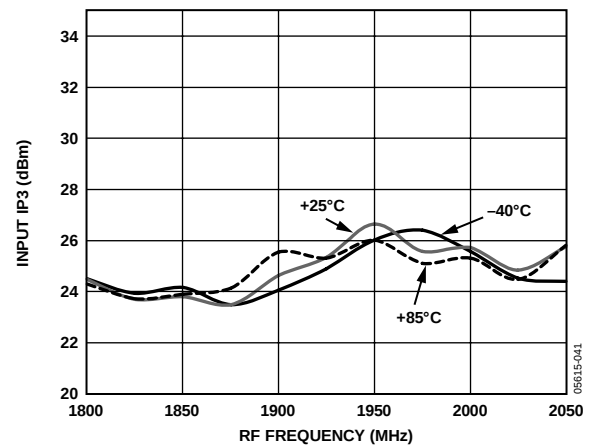


Figure 41. IIP3 vs. RF Frequency

1950 MHz CHARACTERISTICS

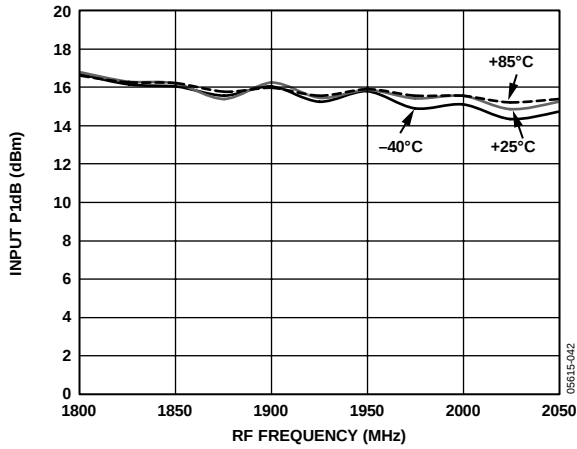


Figure 42. Input Compression vs. RF Frequency

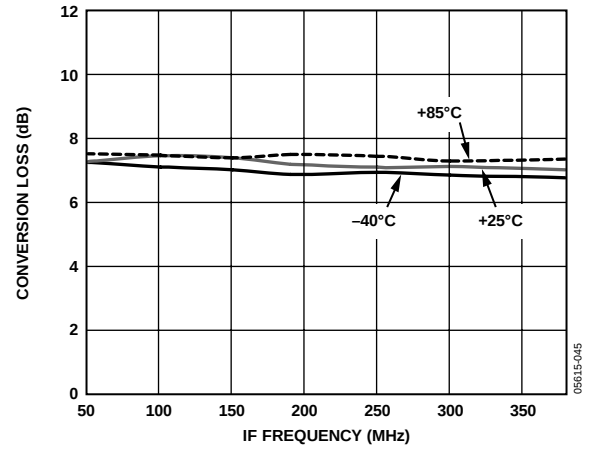


Figure 45. Conversion Loss vs. IF Frequency

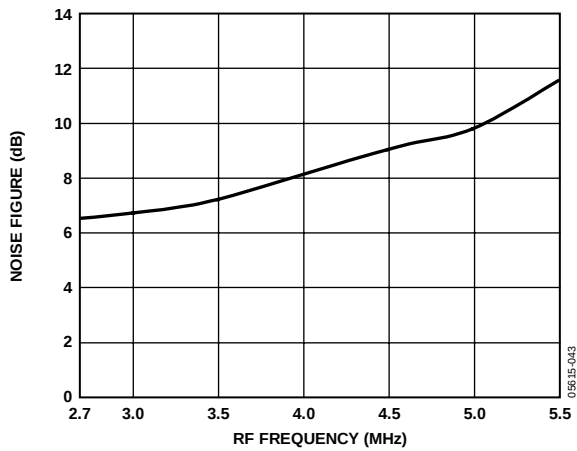


Figure 43. Noise Figure vs. RF Frequency

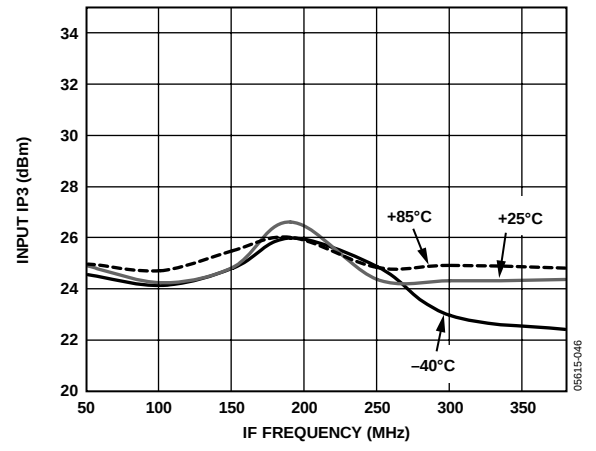


Figure 46. IIP3 vs. IF Frequency

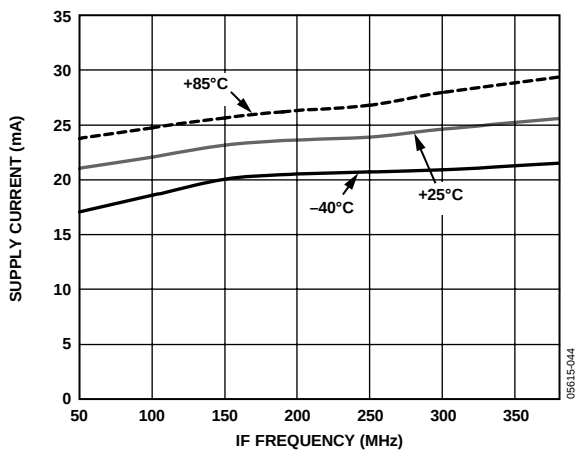


Figure 44. Current vs. IF Frequency

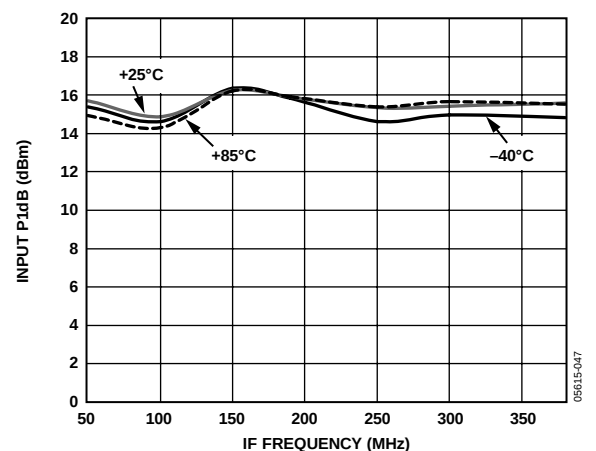


Figure 47. Input Compression vs. IF Frequency

1950 MHz CHARACTERISTICS

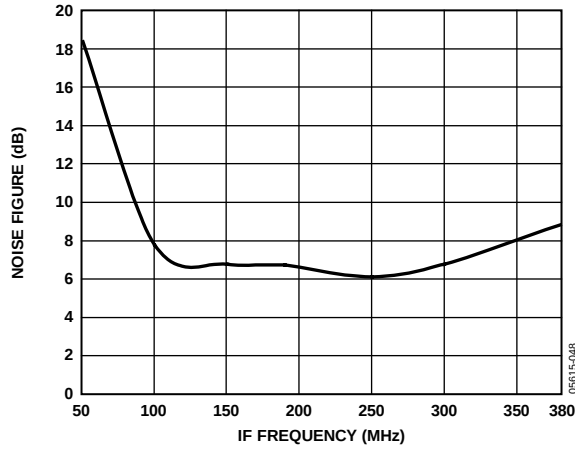


Figure 48. Noise Figure vs. IF Frequency

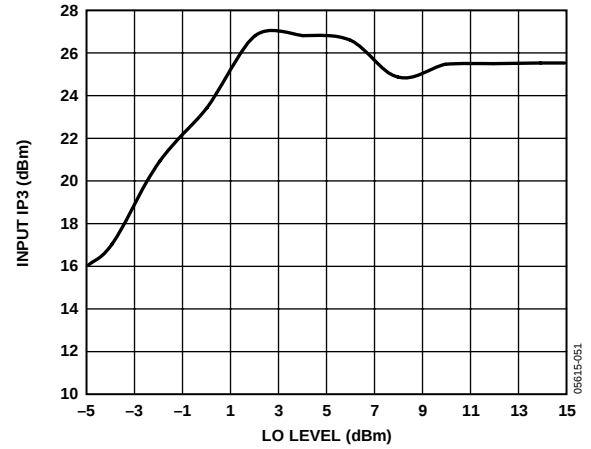


Figure 51. IIP3 vs. LO Level

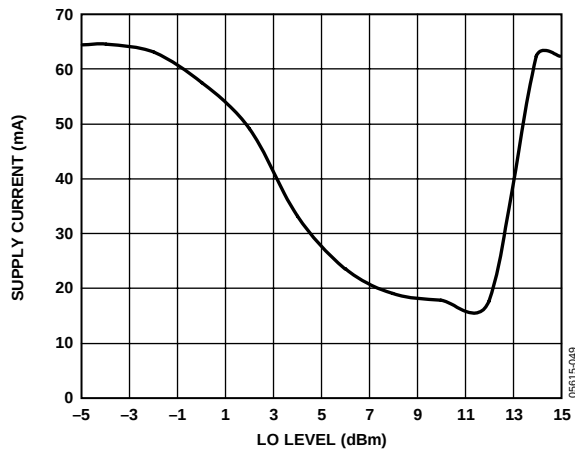


Figure 49. Current vs. LO Level

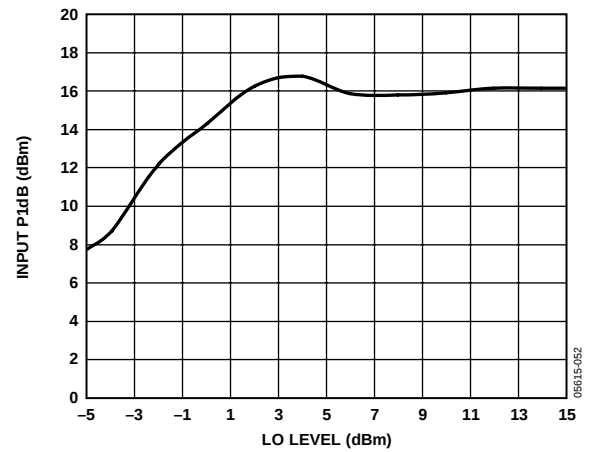


Figure 52. Input Compression vs. LO Level

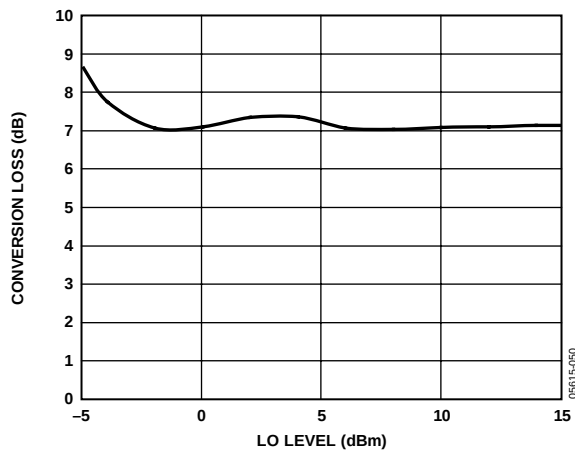


Figure 50. Conversion Loss vs. LO Level

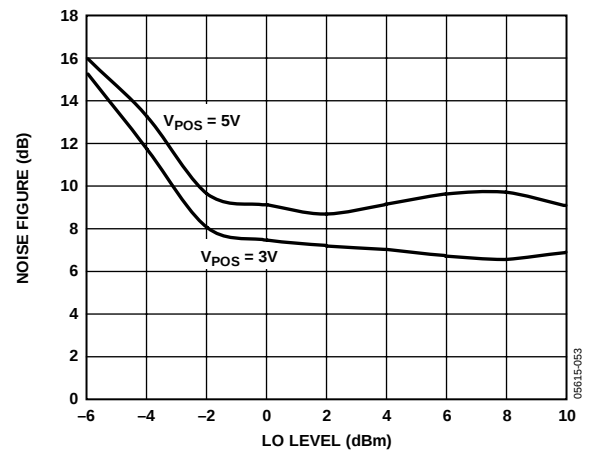


Figure 53. Noise Figure vs. LO Level

1950 MHz CHARACTERISTICS

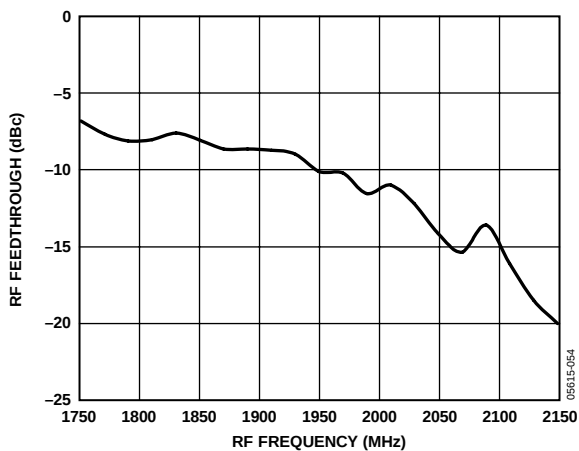


Figure 54. RF to IF Feedthrough vs. RF Frequency

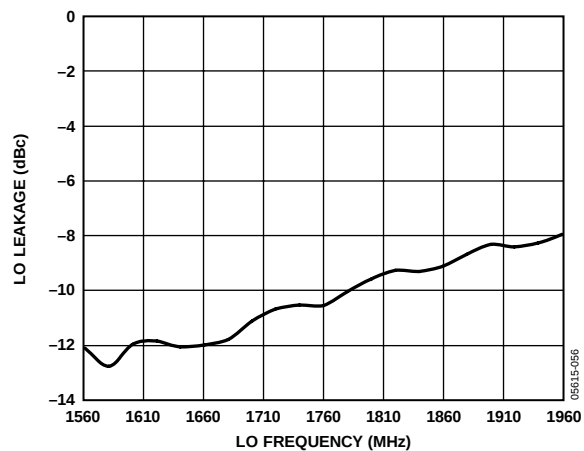


Figure 56. LO to RF Leakage vs. LO Frequency

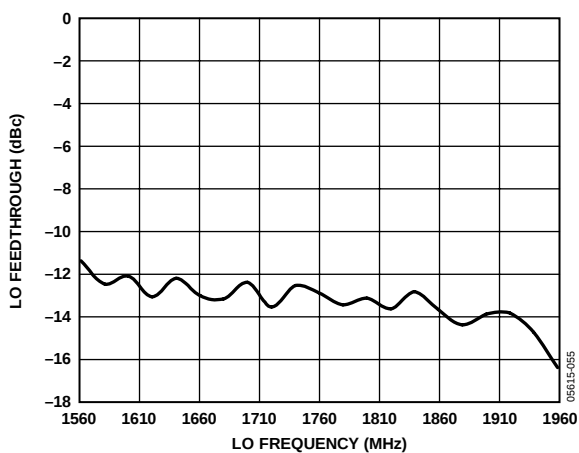


Figure 55. LO to IF Feedthrough vs. LO Frequency

2. Tune the LO port input network for optimum return loss.

Typically, a bandpass network is used to pass the LO signal to the LOIN pin. It is desirable to block high frequency harmonics of the LO from the mixer core. LO harmonics cause higher RF frequency images to be down converted to the desired IF frequency, and result in a sensitivity degradation. If the intended LO source has poor harmonic distortion and spectral purity, it may be necessary to employ a higher order bandpass filter network. Figure 58 illustrates a simple L-C bandpass filter used to pass the fundamental frequency of the LO source. Capacitor C3 is a simple DC block, while the series-inductor (L3), along with the gate-to-source capacitance of the buffer amplifier, form a low-pass network. The native gate input of the LO buffer (FET) presents a rather high input impedance alone. The gate bias is generated internally using feedback that can result in a positive return loss at the intended LO frequency. If a better than –10 dB return loss is desired, it may be necessary to add shunt resistor to ground before the coupling capacitor (C3) to present a lower loading impedance to the LO source .

3. Design the RF and IF filter networks.

Figure 58 depicts simple LC tank filter networks for the IF and RF port interfaces. The RF port LC network is designed to pass the RF input signal. The series LC tank has a resonant frequency at $1/(2\pi\sqrt{LC})$. At resonance, the series reactances cancel, which presents a series short to the RF signal. A parallel LC tank is used on the IF port to reject the RF and LO signals. At resonance, the parallel LC tank presents an open circuit.

It is necessary to accommodate for the board parasitics, finite Q, and self-resonant frequencies of the LC components when designing the RF, IF, and LO filter networks. Table 9 provides suggested values for initial prototyping.

Table 9. Suggested RF, IF, and LO Filter Networks for Low-Side LO Injection

RF Frequency	L1 ¹	C1	L2	C2	L3	C3
450 MHz	8.3 nH	10 pF	10 nH	10 pF	10 nH	100 pF
850 MHz	6.8 nH	4.7 pF	4.7 nH	5.6 pF	8.2 nH	100 pF
1950 MHz	1.7 nH	1.5 pF	1.7 nH	1.2 pF	3.5 nH	100 pF
2400 MHz	0.67 nH	1 pF	1.5 nH	0.7pF	3.0 nH	100 pF

¹ The inductor should have a self-resonant frequency greater than the intended frequency of operation. L1 should be a high Q inductor for optimum NF performance.

LOW FREQUENCY APPLICATIONS

The circuit in Figure 60 is designed for a RF of 70 MHz and an IF of 10.7 MHz. The LO is at 59.3 MHz (Low Side LO). The series resonant circuit is designed for 70 MHz and the parallel resonant circuit is designed for 65 MHz.



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Figure 60. 70 MHz to 10.7 MHz Down-Conversion Schematic

70 MHz RECEIVE PERFORMANCE

$V_S = 3\text{ V}$, $T_A = 25^\circ\text{C}$, LO power = 4 dBm, re: 50 Ω , unless otherwise noted.

Table 10.

Parameter		Unit
RF Frequency	60	MHz
LO Frequency	59.3	MHz
IF Frequency	10.7	MHz
Conversion Loss	6.7	dB
SSB Noise Figure	6.7	dB
Input Third-Order Intercept	27.3	dBm
Supply Voltage	3	V
Supply Current	18	mA

Table 11 shows the spur performance for RF = 70 MHz and LO = 59.3 MHz; RFin = -5 dBm, Loin=4 dBm; all values in dBc referenced to RFin.

Note that higher order spurious components falling in-band do become an issue as the bandwidth of the desired signal increases. Therefore, while operation at IF frequencies as low as 10 MHz is possible, the bandwidth of this signal needs to be taken into consideration.

Table 11. $N \times f_{RF} - M \times f_{LO}$ -Mixer Spurious Products

		M															
		0.0	1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	10.0	11.0	12.0	13.0	14.0	15.0
N	0.0	-6.8	-30.5	-23.3	-30.5	-28.9	-34.9	-41.1	-45.7	-37.8	-39.7	-42.3	-37.5	-48.8	-40.1	-39.1	-37.4
	1.0	-15.3	-6.8	-18.1	-37.3	-19.8	-22.6	-41.5	-24.2	-26.9	-42.4	-27.7	-30.1	-43.4	-30.2	-32.9	-44.3
	2.0	-51.5	-66.0	-57.8	-57.4	-63.1	-57.8	-55.6	-59.2	-56.3	-55.7	-61.3	-57.1	-55.7	-58.3	-56.8	-57.6
	3.0	-71.4	-78.8	-73.1	-75.1	-80.6	-81.8	-78.3	-78.2	-72.3	-82.3	-77.7	-82.4	-76.3	-73.3	-74.3	-79.2
	4.0	-82.9	-78.6	-81.0	-84.2	-79.7	-77.5	-76.6	-79.0	-74.9	-75.0	-75.8	-76.3	-89.2	-76.7	-87.9	-76.1
	5.0	-76.2	-82.9	-78.6	-75.4	-78.7	-84.9	-77.6	-79.2	-84.5	-85.0	-75.9	-81.3	-74.9	-98.6	-73.6	-90.4
	6.0	-88.6	-74.6	-79.1	-80.2	-77.1	-76.1	-85.8	-76.2	-81.2	-82.9	-89.7	-75.4	-82.9	-85.4	-78.1	-75.9
	7.0	-90.6	-76.7	-79.9	-80.6	-81.0	-83.4	-73.1	-76.8	-77.9	-84.6	-80.0	-78.4	-73.2	-75.2	-79.3	-90.9
	8.0	-81.8	-80.4	-84.6	-84.9	-79.5	-83.1	-80.1	-78.6	-89.9	-78.7	-75.3	-77.0	-81.6	-86.3	-85.0	-77.1
	9.0	-90.2	-78.3	-80.2	-71.9	-73.9	-85.8	-82.2	-86.6	-80.2	-78.7	-79.1	-71.2	-78.8	-76.0	-84.5	-81.8
	10.0	-78.2	-82.1	-80.3	-73.5	-86.6	-86.1	-81.0	-86.0	-78.2	-86.2	-87.1	-83.7	-79.8	-75.0	-83.8	-82.4
	11.0	-77.6	-85.8	-78.4	-85.1	-86.6	-80.1	-79.4	-78.8	-69.3	-82.8	-81.6	-94.2	-81.7	-80.5	-84.1	-77.2
	12.0	-89.4	-90.8	-80.8	-71.7	-73.4	-75.5	-82.2	-76.8	-72.1	-78.0	-76.3	-84.9	-85.6	-78.7	-71.8	-85.1
	13.0	-80.0	-82.5	-79.6	-82.0	-78.9	-78.5	-73.4	-80.4	-84.9	-81.5	-79.4	-79.1	-76.1	-82.8	-77.8	-71.7
	14.0	-86.3	-85.6	-89.2	-85.6	-82.7	-74.4	-88.1	-77.6	-74.4	-79.0	-85.4	-89.1	-88.4	-77.2	-81.1	-80.0
	15.0	-84.4	-81.9	-81.1	-87.9	-77.7	-83.3	-78.4	-81.9	-90.0	-73.3	-84.6	-77.8	-81.7	-81.2	-93.2	-71.4

HIGH FREQUENCY APPLICATIONS

The ADL5350 can be used at extended frequencies with some careful attention to board and component parasitics. Figure 61 is an example of a 2.3 GHz to 2.5 GHz down-conversion using a low-side LO. The performance of this circuit is depicted in Figure 62. Note that the inductor and capacitor values are very small, especially for the RF and IF ports. Above 2.5 GHz, it is necessary to consider alternate solutions to avoid unreasonably small inductor and capacitor values.

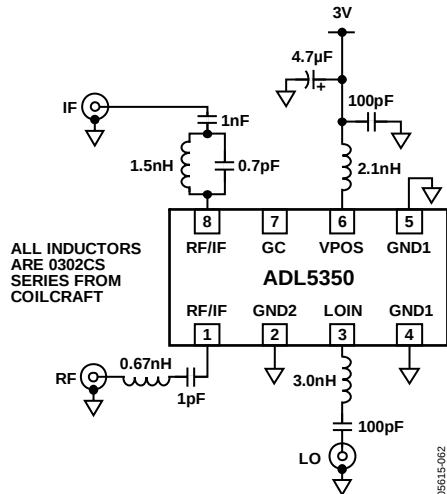


Figure 61. 2.3 GHz to 2.5 GHz Down-Conversion Schematic

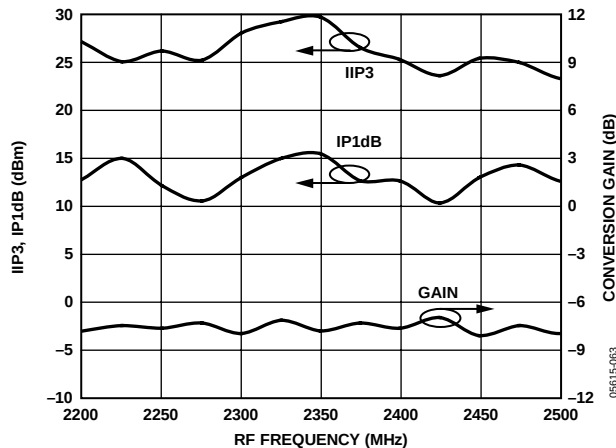


Figure 62. Measured Performance for Circuit in Figure 61 Using Low-Side LO Injection and 374 MHz IF

The typical networks used for cellular applications below 2.5 GHz utilize band-select and band-reject networks on the RF and IF ports. At higher RF frequencies, these networks are not easily realized using lumped element components (discrete Ls and Cs). As a result, it is necessary to consider alternate filter network topologies to allow more reasonable values of inductors and capacitors.

Figure 63 depicts a cross-over filter network approach to provide isolation between the RF and IF ports for a down-converting application. The cross-over network essentially provides a high-pass filter to allow the RF signal to pass to the RF/IF node (Pin 1 and Pin 8), while presenting a low-pass filter, (which is actually band-pass when considering the DC blocking capacitor, C_{AC}). This allows the difference component ($f_{RF} - f_{LO}$) to be passed to the desired IF load.

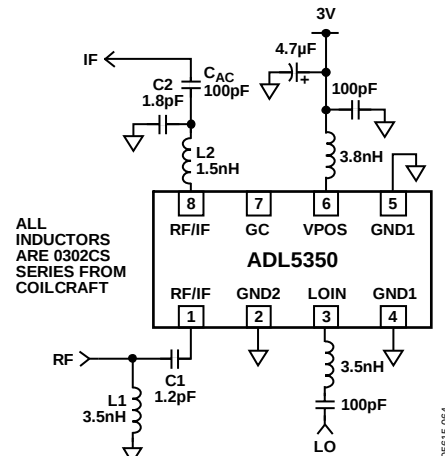


Figure 63. 3.3 GHz to 3.8 GHz Down-Conversion Schematic

When designing the RF and IF port networks, it is important to remember that the networks share a common node (the RF/IF pins). In addition, the opposing network presents some loading impedance to the target network being designed. Classic audio crossover filter design techniques can be applied to help derive component values. However, some caution must be applied when selecting component values. At high RF frequencies, the board parasitics may significantly influence the final optimum inductor and capacitor component selections. Some empirical testing may be necessary to optimize the RF and IF port filter networks. The performance of the circuit depicted in Figure 63 is provided in Figure 64.

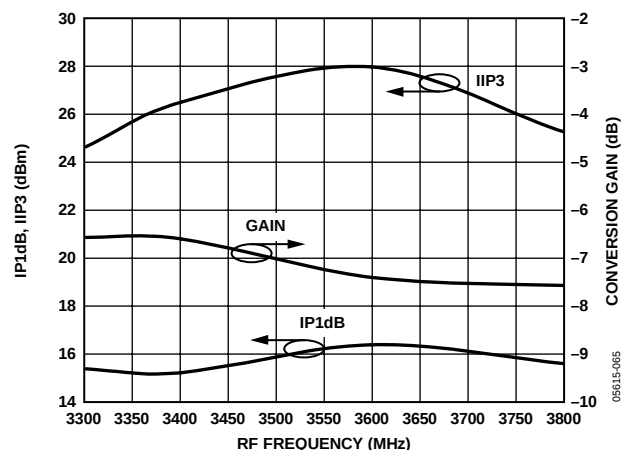


Figure 64. Measured Performance for Circuit in Figure 63

EVALUATION BOARD

An evaluation board is available for the ADL5350. The evaluation board has two halves: a low band designated as Board A, and a high band board designated as Board B. The schematic for the evaluation board is presented in Figure 65.

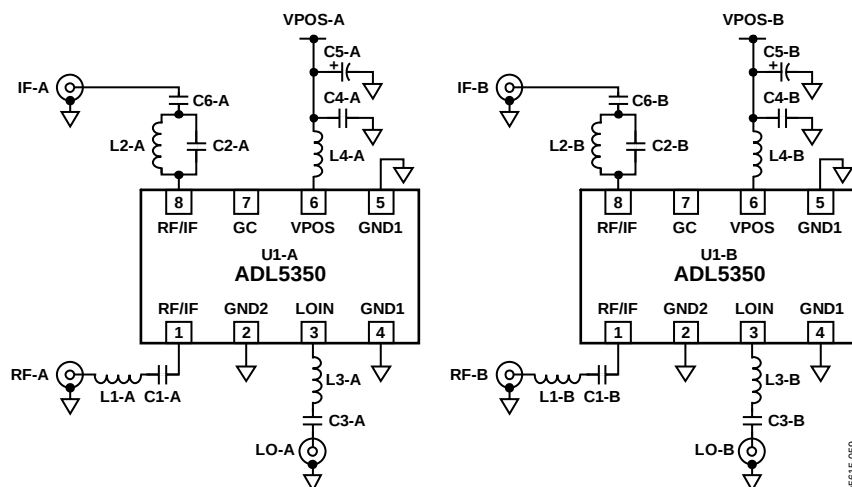


Figure 65. Evaluation Board

Table 12. Evaluation Board Configuration Options

Component	Function	Default Conditions
C4-A, C4-B, C5-A, C5-B	Supply Decoupling. C4-A and C4-B provide local bypassing of the supply. C5-A and C5-B are used to filter the ripple of a noisy supply line. These are not always necessary.	C4-A = C4-B = 100 pF C5-A = C5-B = 4.7 μ F
L1-A, L1-B, C1-A, C1-B	RF Input Network. Designed to provide series resonance at the intended RF frequency.	L1-A = 6.8 nH (0603CS from Coilcraft) L1-B = 1.7 nH (0302CS from Coilcraft) C1-A = 4.7 pF, C1-B = 1.5 pF
L2-A, L2-B, C2-A, C2-B, C6-A, C6-B	IF Output Network. Designed to provide parallel resonance at the geometric mean of the RF and LO frequencies.	L2-A = 4.7 nH (0603CS from Coilcraft) L2-B = 1.7 nH (0302CS from Coilcraft) C2-A = 5.6 pF, C2-B = 1.2 pF C6-A = C6-B = 1 nF
L3-A, L3-B, C3-A, C3-B	LO Input Network. Designed to block DC and optimize LO voltage swing at LOIN.	L3-A = 8.2 nH (0603CS from Coilcraft) L3-B = 3.5 nH (0302CS from Coilcraft) C3-A = C3-B = 100 pF
L4-A, L4-B	LO Buffer Amp Choke. Provides bias and ac loading impedance to LO buffer amp.	L4-A = 24 nH (0603CS from Coilcraft) L4-B = 3.8 nH (0302CS from Coilcraft)

OUTLINE DIMENSIONS

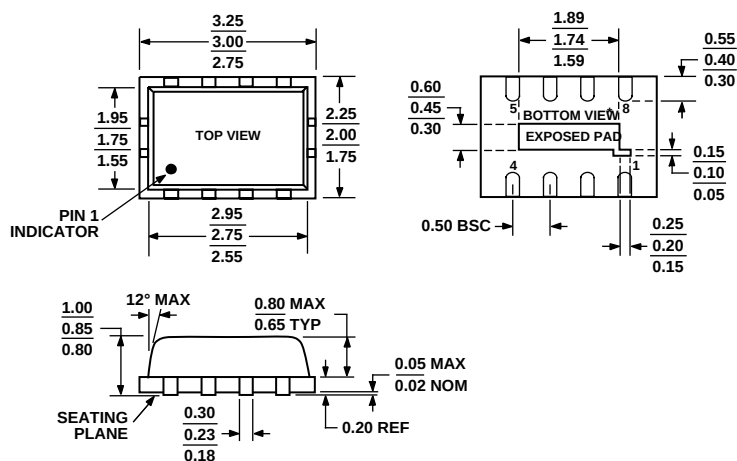


Figure 66. 8-Lead Lead Frame Chip Scale Package [LFCSP_VD]
 2 mm × 3 mm Body, Very Thin, Dual Lead
 (CP-8-1)
 Dimensions shown in millimeters

ORDERING GUIDE

Models	Temperature Range	Package Description	Package Option	Branding	Ordering Quantity
ADL5350ACPZ-R2 ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-1	Q7	250, Reel
ADL5350ACPZ-R7 ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-1	Q7	3000, Reel
ADL5350ACPZ-WP ¹	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP_VD]	CP-8-1	Q7	50, Waffle Pack
ADL5350-EVAL		Evaluation Board			1

¹ Z = Pb-free part.